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December 2001

FAIRCHILD SEMICONDUCTOR®

FDC6318P

Dual P-Channel 1.8V PowerTrench[®] Specified MOSFET

General Description

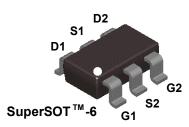
These P-Channel 1.8V specified MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain low gate charge for superior switching performance.

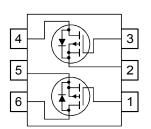
Applications

- Power management
- Load switch

Features

- -2.5 A, -12 V. $R_{DS(ON)} = 90 \text{ m}\Omega \textcircled{0} V_{GS} = -4.5 \text{ V}$ $R_{DS(ON)} = 125 \text{ m}\Omega \textcircled{0} V_{GS} = -2.5 \text{ V}$ $R_{DS(ON)} = 200 \text{ m}\Omega \textcircled{0} V_{GS} = -1.8 \text{ V}$
- + High performance trench technology for extremely low $\rm R_{\rm _{DS(ON)}}$
- SuperSOTTM-6 package: small footprint (72% smaller than standard SO-8); low profile (1mm thick)





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter Drain-Source Voltage Gate-Source Voltage		Ratings	Units	
V _{DSS}			-12	V V	
V _{GSS}			±8		
ID	Drain Current – Continuous	(Note 1a)	-2.5	A	
	– Pulsed		-7		
PD	Power Dissipation for Single Operation	(Note 1a)	0.96	W	
		(Note 1b)	0.9		
		(Note 1c)	0.7		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		–55 to +150	°C	

R_{BJA}Thermal Resistance, Junction-to-Ambient(Note 1a)130°C/WR_{BJC}Thermal Resistance, Junction-to-Case(Note 1)60°C/W

Package Marking and Ordering Information

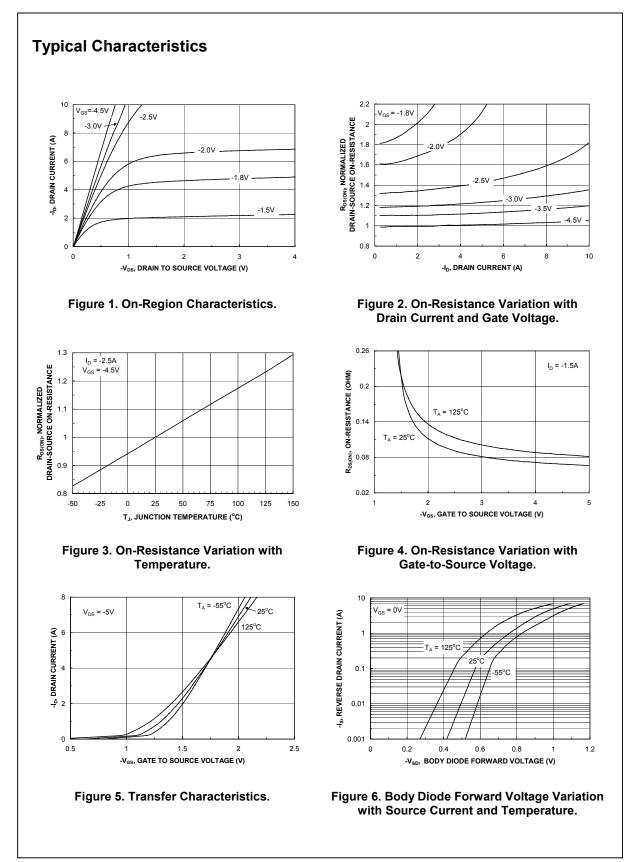
.318 FDC6318P 13" 12mm 3000 u	Device Marking	Device	Reel Size	Tape width	Quantity
	.318	FDC6318P	13"	12mm	3000 units

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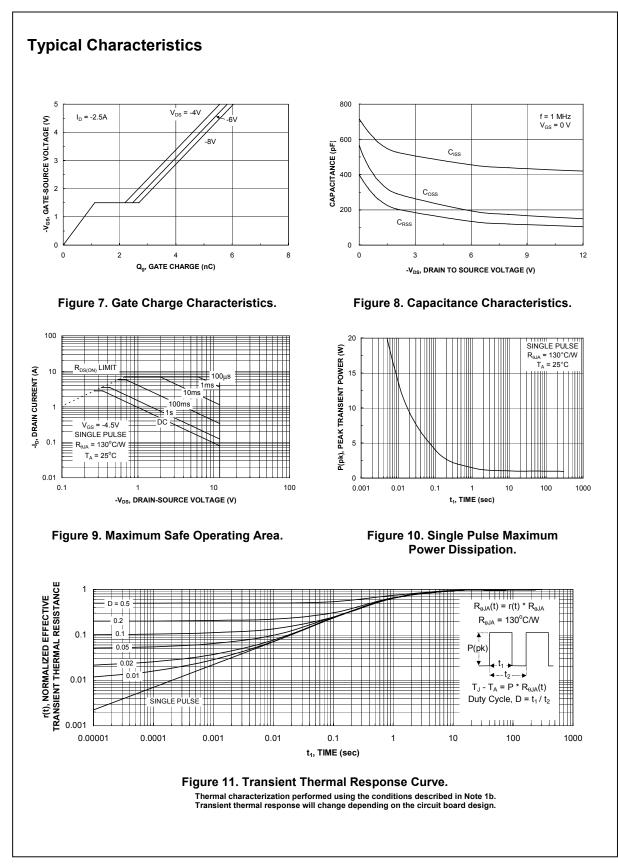
FDC6318P

Cteristics Drain–Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current	V_{GS} = 0 V, I_D = -250 µA I_D = -250 µA, Referenced to 25°C	-12	г	<u>ı </u>	L
Orain–Source Breakdown Voltage Breakdown Voltage Temperature Coefficient			1		
Coefficient			1		V
ero Gate Voltage Drain Current			-2.9		mV/°C
	$V_{DS} = -10 V$, $V_{GS} = 0 V$			-1	μA
Sate–Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
Gate-Body Leakage, Reverse	V_{GS} = -8 V, V_{DS} = 0 V			-100	nA
Cteristics (Note 2)					
Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-0.4	-0.7	-1.5	V
Gate Threshold Voltage	I_D = –250 µA, Referenced to 25°C		2.3		mV/°C
Static Drain–Source Dn–Resistance	$ \begin{array}{l} V_{GS} = -4.5 \ V, I_D = -2.5 \ A \\ V_{GS} = -2.5 \ V, I_D = -2 \ A \\ V_{GS} = -1.8 \ V, I_D = -1.6 \ A \\ V_{GS} = -4.5 \ V, \ I_D = -2.5 \ A, \ T_J = 125^\circ C \end{array} $;	69 93 135 85	90 125 200 120	mΩ
Dn-State Drain Current	$V_{GS} = -4.5 V$, $V_{DS} = -5 V$	-6			Α
orward Transconductance	$V_{DS} = -5 V$, $I_D = -2.5 A$		8		S
Characteristics					
nput Capacitance	$V_{DS} = -6 V$, $V_{GS} = 0 V$,		455		pF
Dutput Capacitance	f = 1.0 MHz		194		pF
Reverse Transfer Capacitance	1		134		pF
Characteristics (Note 2)			1	<u> </u>	
Furn-On Delay Time	$V_{DD} = -6 V$ $I_D = -1 A.$		9	18	ns
urn–On Rise Time	$V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		14	25	ns
urn–Off Delay Time	•		21	34	ns
urn–Off Fall Time			17	31	ns
	$V_{DS} = -6 V$. $I_D = -2.5 A$.	+	5.4	8	nC
Sate-Source Charge	$V_{GS} = -4.5 V$		1.1	-	nC
Gate-Drain Charge			1.3		nC
ů	and Maximum Datings		_ ··-		
		<u> </u>	1	-0.8	А
		+		0.0	
/oltage	$V_{GS} = 0 V$, $I_S = -0.8 A$ (Note 2))	-0.7	-1.2	V
	cteristics (Note 2) Sate Threshold Voltage Sate Transfer Capacitance Characteristics (Note 2) Sate Transfer Capacitance Characteristics (Note 2) Sate Transfer Capacitance Characteristics (Note 2) Sate Transfer Capacitance Sate Transfer Capacitan	teristics (Note 2)Sate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \mu$ ASate Threshold Voltage $I_D = -250 \mu$ A, Referenced to 25°Cemperature Coefficient $I_D = -250 \mu$ A, Referenced to 25°Cwitatic Drain–Source $V_{GS} = -4.5 V$, $I_D = -2.5 A$ $V_{GS} = -2.5 V$, $I_D = -2.5 A$ $V_{GS} = -2.5 V$, $I_D = -2.5 A$ $V_{GS} = -4.5 V$, $I_D = -2.5 A$, $V_{GS} = -4.5 V$, $I_D = -2.5 A$ $V_{GS} = -4.5 V$, $I_D = -2.5 A$ $On-State Drain Current$ $V_{GS} = -4.5 V$, $V_{DS} = -5 V$ $On-State Drain Current$ $V_{GS} = -4.5 V$, $V_{DS} = -5 V$ $On-State Drain Current$ $V_{DS} = -6 V$, $V_{DS} = -0 V$ $On-State Drain Current$ $V_{DS} = -6 V$, $V_{GS} = 0 V$, $f = 1.0 MHz$ $V_{DD} = -6 V$, $I_D = -1 A$, V_{TM} -On Delay Time $V_{DD} = -6 V$, $I_D = -1 A$, V_{TM} -On Rise Time $V_{DS} = -6 V$, $I_D = -1 A$, $V_{GS} = -4.5 V$, $R_{GEN} = 6 \Omega$ V_{DT} -Off Delay Time $V_{DS} = -6 V$, $I_D = -2.5 A$, $V_{DS} = -6 V$, $I_D = -2.5 A$, $V_{GS} = -4.5 V$, $R_{GEN} = 6 \Omega$ V_{TM} -On Rise Time $V_{DS} = -6 V$, $I_D = -2.5 A$, $V_{GS} = -4.5 V$, $R_{GEN} = 6 \Omega$ $V_{DS} = -6 V$, $I_D = -2.5 A$, $V_{GS} = -4.5 V$ $V_{DS} = -6 V$, $I_D = -2.5 A$, $V_{GS} = -0.5 V$ $V_{DS} = -0.5 V$	teristics (Note 2)Gate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$ -0.4 Gate Threshold Voltage $I_D = -250 \ \mu A$, Referenced to $25^{\circ}C$ $I_D = -250 \ \mu A$, Referenced to $25^{\circ}C$ Gate Threshold Voltage $V_{GS} = -4.5 \ V$, $I_D = -2.5 \ A$ $V_{GS} = -2.5 \ V$, $I_D = -2.5 \ A$ Dn-Resistance $V_{GS} = -4.5 \ V$, $I_D = -2.5 \ A$ $V_{GS} = -4.5 \ V$, $I_D = -2.5 \ A$ Dn-State Drain Current $V_{GS} = -4.5 \ V$, $I_D = -2.5 \ A$ -6 On-State Drain Current $V_{GS} = -4.5 \ V$, $I_D = -2.5 \ A$ -6 On-State Drain Current $V_{GS} = -5 \ V$, $I_D = -2.5 \ A$ -6 On-State Drain Current $V_{GS} = -5 \ V$, $I_D = -2.5 \ A$ -6 On-State Drain Current $V_{GS} = -4.5 \ V$, $V_{DS} = -5 \ V$ -6 On-State Drain Current $V_{GS} = -6 \ V$, $V_{GS} = 0 \ V$, -6 On-State Characteristics(Note 2) $V_{DD} = -6 \ V$, $I_D = -1 \ A$,Uurn-On Delay Time $V_{DD} = -6 \ V$, $I_D = -1 \ A$, -6 Uurn-On Rise Time $V_{GS} = -4.5 \ V$, $R_{GEN} = 6 \ \Omega$ -6 Uurn-Off Fall Time $V_{GS} = -4.5 \ V$ $I_D = -2.5 \ A$,Uurn-Off Fall Time $V_{GS} = -6 \ V$, $I_D = -2.5 \ A$, $-6 \ O$ Otal Gate Charge $V_{GS} = -6 \ V$, $I_D = -2.5 \ A$, $-6 \ O$ State-Drain Charge $V_{GS} = -4.5 \ V$ $I_D = -2.5 \ A$,State-Drain Charge $V_{GS} = -4.5 \ V$ $I_D = -2.5 \ A$,State-Drain Charge $V_{GS} = -4.5 \ V$ $I_D = -2.5 \ A$,State-Drain Charge $V_{GS} = -4.5 \ $	teristics (Note 2)Sate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \ \mu$ A -0.4 -0.7 Sate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25° C2.3Sate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25° C2.3Sate Threshold Voltage $V_{GS} = -4.5 \ V$, $I_D = -2.5 \ A$ 69In-Resistance $V_{GS} = -4.5 \ V$, $I_D = -2.5 \ A$ 93 $V_{GS} = -1.8 \ V$, $I_D = -2.5 \ A$ 93 $V_{GS} = -4.5 \ V$, $I_D = -2.5 \ A$ 93 $V_{GS} = -4.5 \ V$, $I_D = -2.5 \ A$ 85On-State Drain Current $V_{GS} = -4.5 \ V$, $V_{DS} = -5 \ V$ -6 orward Transconductance $V_{DS} = -5 \ V$, $I_D = -2.5 \ A$ 8 Characteristics $f = 1.0 \ MHz$ 194teverse Transfer Capacitance $V_{DS} = -6 \ V$, $V_{GS} = 0 \ V$, $f = 1.0 \ MHz$ 194teverse Transfer Capacitance $V_{DS} = -6 \ V$, $I_D = -1 \ A$, $9 \ Urn-On Rise Time$ 1134 Characteristics $V_{DS} = -6 \ V$, $I_D = -1 \ A$, $9 \ Urn-On Rise Time$ 117oral Gate Charge $V_{DS} = -6 \ V$, $I_D = -2.5 \ A$, $5.4 \ V_{GS} = -4.5 \ V$ 1.1oral Gate Charge $V_{CS} = -6 \ V$, $I_D = -2.5 \ A$, $5.4 \ V_{GS} = -4.5 \ V$ 1.1oral Gate Charge $V_{CS} = -6 \ V$, $I_D = -2.5 \ A$, $5.4 \ V_{GS} = -4.5 \ V$ 1.1oral Gate Charge $V_{CS} = -6 \ V$, $I_D = -2.5 \ A$, $5.4 \ V_{GS} = -4.5 \ V$ 1.1oral Gate Charge $V_{CS} = 0 \ V$, $I_S = -6 \ A$, $I_D = -2.5 \ A$, $I_A = -2.5 \ A$ 1.1oral Gate Charge $V_{CS} = 0 \ V$, $I_S = -6 \ A$, I_S	teristics (Note 2)Sate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$ -0.4 -0.7 -1.5 Sate Threshold Voltage $I_D = -250 \ \mu A$, Referenced to 25°C2.3emperature Coefficient $I_D = -250 \ \mu A$, Referenced to 25°C2.3static Drain-Source $V_{GS} = -4.5 \ V$, $I_D = -2.5 \ A$ 6990On-Resistance $V_{GS} = -4.5 \ V$, $I_D = -2.5 \ A$ 6990No-Resistance $V_{GS} = -4.5 \ V$, $I_D = -2.5 \ A$ 85120No-State Drain Current $V_{GS} = -4.5 \ V$, $I_D = -2.5 \ A$ 8Characteristics $V_{DS} = -5 \ V$, $I_D = -2.5 \ A$ 8Characteristics $V_{DS} = -6 \ V$, $V_{GS} = 0 \ V$, $I_D = -2.5 \ A$ 8Characteristics $V_{DS} = -6 \ V$, $V_{GS} = 0 \ V$, $I_D = -2.5 \ A$ 8Characteristics $V_{DS} = -6 \ V$, $V_{GS} = 0 \ V$, $I_D = -2.5 \ A$ 8Characteristics (Note 2) I_{134} 194turn-On Delay Time $V_{DD} = -6 \ V$, $I_D = -1 \ A$, 9 18urn-Off Delay Time $V_{DS} = -6 \ V$, $I_D = -1 \ A$, 9 14urn-Off Fall Time I_{17} 31otal Gate Charge $V_{OS} = -6 \ V$, $I_D = -2.5 \ A$, $5.4 \ 8$ State-Source Charge $I_{1.3}$ $I_{1.1}$ state-Drain Charge $I_{1.3}$ $I_{1.1}$ trace Diode Characteristics and Maximum Ratingstaximum Continuous Drain-Source Diode Forward Current $-0.8 \ V_{OS} = 0 \ V$ train-Source Diode Forward $V_{OS} = 0 \ V$ $I_D = -0.8 \ V_{OS} = 0 \ V$

FDC6318P Rev D (W)



FDC6318P



FDC6318P

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	-	Rev. H4

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